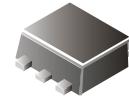


**RoHS Device**
**Halogen Free**

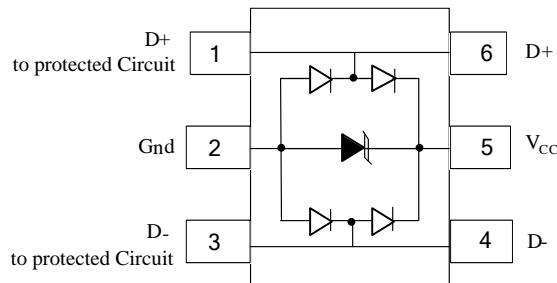
## Features

- 100 Watts Peak Power per Line ( $t_p = 8/20\mu s$ )
- Protects two I/O lines
- Low operating voltage: 5V
- Ultra Low capacitance( $< 1.0\text{ pF}$ ) for high -speed interfaces
- Solid-state technology


**SOT-666**

## Mechanical Characteristics

- JEDEC SOT-666 package
- Molding compound flammability rating: UL 94V-0
- Marking : Making Code
- Packaging : Tape and Reel per EIA 481



## Applications

- FireWire & USB
- Sensitive Analog Inputs
- Portable Electronics
- LAN/WAN equipment
- Video Line Protection
- Microcontroller Input Protection

## IEC COMPATIBILITY (EN61000-4)

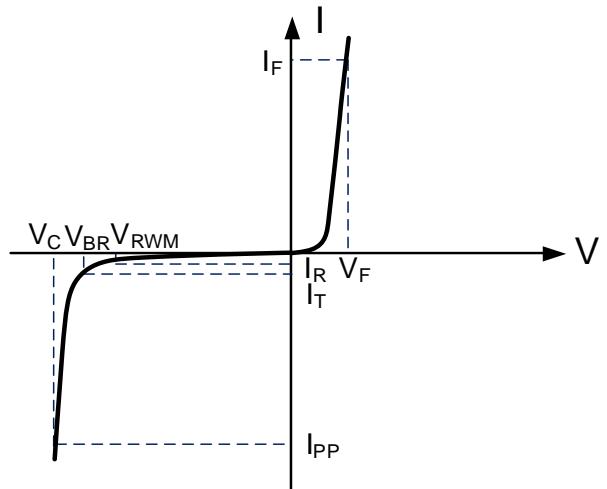
- IEC 61000-4-2 (ESD)  $\pm 15\text{ kV}$  (air),  $\pm 8\text{ kV}$  (contact)
- IEC 61000 -4-4 (EFT) 40A (5/50ns)
- IEC 61000 -4-5 (Lightning) 4A(8/20US)

## Absolute Maximum Rating

Rating	Symbol	Value	Units
Peak Pulse Power ( $t_p=8/20\mu s$ )	$P_{PP}$	100	Watts
Peak Pulse Current ( $t_p=8/20\mu s$ )	$I_{PP}$	4	A
Lead Soldering Temperature	$T_L$	260 (10sec)	°C
Operating Temperature	$T_J$	-55 to + 125	°C
Storage Temperature	$T_{STG}$	-55 to +150	°C

## Electrical Parameters (T=25°C)

Symbol	Parameter
$I_{PP}$	Maximum Reverse Peak Pulse Current
$V_c$	Clamping Voltage @ $I_{PP}$
$V_{RWM}$	Working Peak Reverse Voltage
$I_R$	Maximum Reverse Leakage Current @ $V_{RWM}$
$V_{BR}$	Breakdown Voltage @ $I_T$

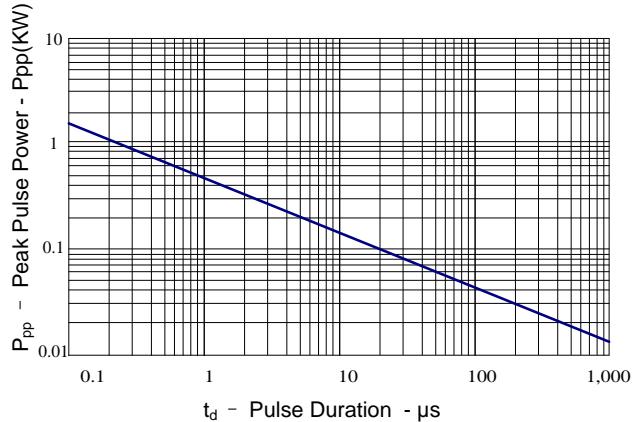


## Electrical Characteristics

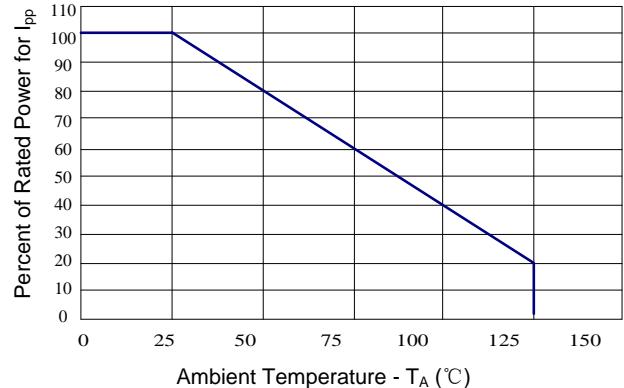
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	$V_{RWM}$				5.0	V
Breakdown Voltage	$V_{BR}$	$I_T=1\text{mA}$	6.0			V
Reverse Leakage Current	$I_R$	$V_{RWM}=5\text{V}, T=25^\circ\text{C}$			1.0	$\mu\text{A}$
Clamping Voltage	$V_c$	$I_{PP}=1\text{A}, t_p=8/20\mu\text{s}$		10		V
Clamping Voltage	$V_c$	$I_{PP}=4\text{A}, t_p=8/20\mu\text{s}$		25		V
Junction Capacitance	$C_j$	Between I/O pins and Ground $V_R=0\text{V}, f=1\text{MHz}$		0.8	1.0	$\text{pF}$
		Between I/O pins $V_R=0\text{V}, f=1\text{MHz}$		0.4	0.6	$\text{pF}$

## Typical Characteristics

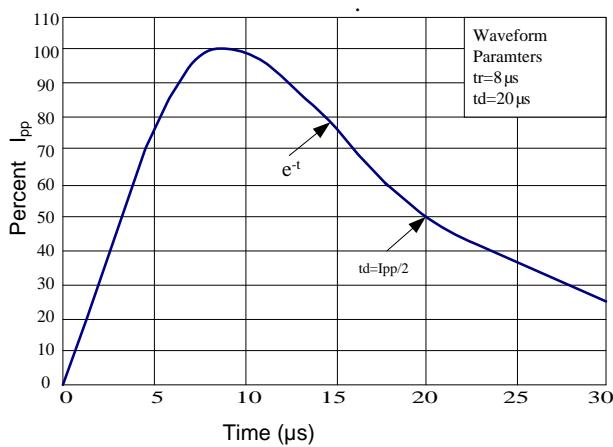
**Figure 1: Peak Pulse Power Vs Pulse Time**



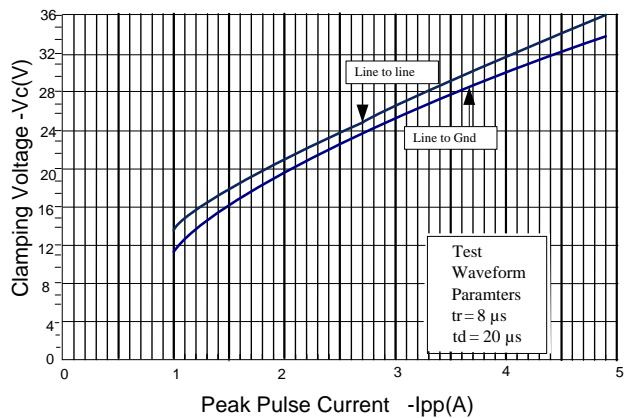
**Figure 2: Power Derating Curve**



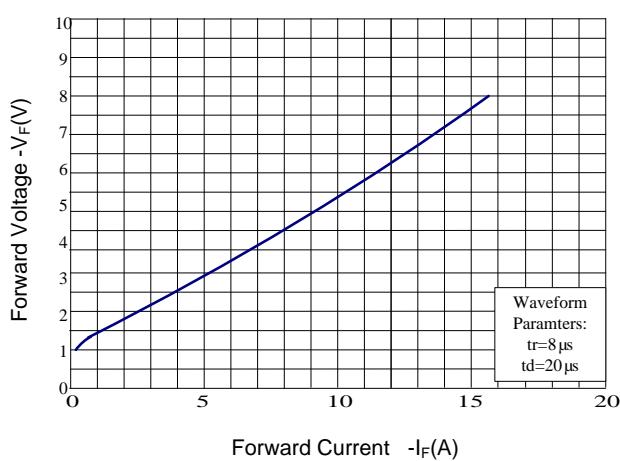
**Figure 3: Pulse Waveform**



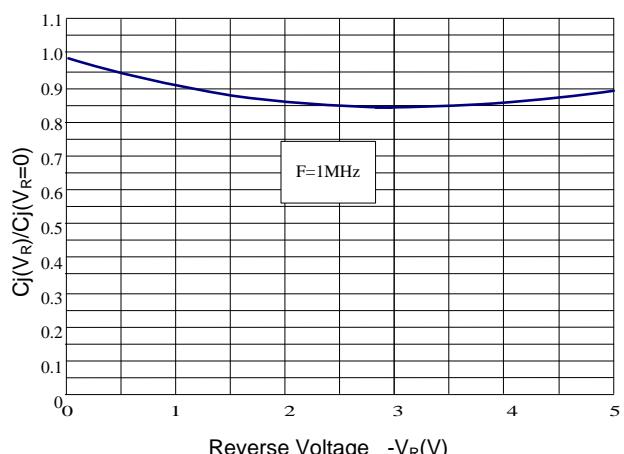
**Figure 4: Clamping Voltage vs. Peak Pulse Current**



**Figure 5: Forward Voltage vs. Forward Current**



**Figure 6: Capacitance vs. Reverse Voltage**

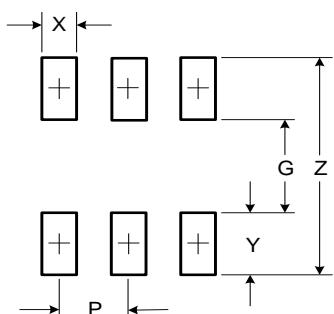


### Outline Drawing SOT-666

PACKAGE OUTLINE		DIMENSIONS			
SYMBOL	INCHES		MILLIMETER		
	MIN	MAX	MIN	MAX	
A	0.021	0.024	0.525	0.600	
A1	0.000	0.002	0.000	0.050	
e	0.018	0.022	0.450	0.550	
c	0.004	0.006	0.090	0.160	
D	0.059	0.067	1.500	1.700	
b	0.007	0.011	0.170	0.270	
E1	0.043	0.051	1.100	1.300	
E	0.059	0.067	1.500	1.700	
L	0.004	0.012	0.100	0.300	
$\theta$	7°REF		7°REF		

DIMENSIONS		
DIM	INCHES	MILLIMETERS
Z	0.0752	1.91
G	0.0350	0.89
P	0.020TYP	0.51 TYP
X	0.0118	0.3
Y	0.0201	0.51



#### Notes

1. Dimensioning and tolerances per ANSI Y14.5M, 1985.
2. Controlling Dimension: Inches
3. Dimensions are exclusive of mold flash and metal burrs.